

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







HCMS-235x

CMOS Extended Temperature Range 5 x 7 Alphanumeric Display



Data Sheet



Description

This sunlight viewable 5 x 7 LED four-character display is contained in 12 pin dual-in-line packages designed for displaying alphanumeric information. The display is designed with on-board CMOS integrated circuits. Two CMOS ICs form an on-board 28-bit serial-in/parallel-out shift register with constant current output LED row drivers. Decoded column data is clocked into the on-board shift register for each refresh cycle. Full character display is achieved with external column strobing.

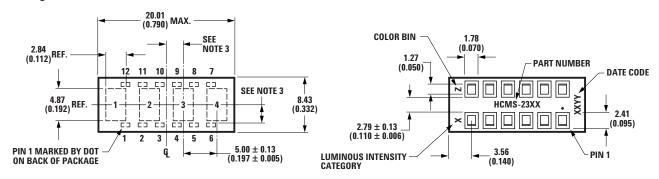
Typical Applications

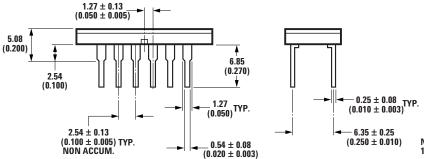
- Avionics
- Communication systems
- Fire control systems
- Radar systems

Features

- On-Board low power CMOS IC
 Integrated shift register with constant current LED drivers
- Wide operating temperature range -55°C to +100°C
- Compact glass ceramic 4 character package Series X-Y stackable
- Sunlight viewable
- 5 x 7 LED matrix displays full ASCII set
- Character height of 5.0 mm (0.20 inch)
- Wide viewing angle
 X Axis = ±50°
 - Y Axis = $\pm 65^{\circ}$
- Usable in night vision lighting applications

Package Dimensions





PIN	FUNCTION	PIN	FUNCTION
1	COLUMN 1	7	DATA OUT
2	COLUMN 2	8	VB
3	COLUMN 3	9	V _{DD}
4	COLUMN 4	10	CLOCK
5	COLUMN 5	11	GROUND
6	INT. CONNECT*	12	DATA IN

* DO NOT CONNECT OR USE

NOTES:

- 1. DIMENSIONS IN MILLIMETERS (INCHES).
- 2. UNLESS OTHERWISE SPECIFIED, THE TOLERANCE ON ALL DIMENSIONS IS $\pm~0.38~\text{mm}~(\pm~0.015).$
- 3. CHARACTERS ARE CENTERED WITH RESPECT TO LEADS WITHIN \pm 0.13 mm (\pm 0.005).
- 4. LEAD MATERIAL IS COPPER ALLOY, SOLDER DIPPED.

Absolute Maximum Ratings

Parameter	Value
Supply Voltage V _{DD} to Ground	-0.3 V to 7.0 V ^[1]
Data Input, Data Output, V _B	–0.3 V to V _{DD}
Column Input Voltage, V _{COL}	–0.3 V to V _{DD}
Free Air Operating Temperature Range, T _A	−55°C to +100°C
Storage Temperature Range, T _s	−55°C to +100°C
Maximum Allowable Package Power Dissipation, $P_D^{[2,3]}$ at $T_A = 71^{\circ}C$	1.31 Watts
Through-the-Wave Solder Temperature [4]	250°C for 3 secs. max.
Solder Dipping Temperature [4]	260°C for 5 secs. max.
ESD Protection @ 1.5 kΩ, 100 pF	$V_Z = 4 \text{ kV}$
·	

Notes:

- 1. Maximum duration 2 seconds.
- 2. Maximum allowable power dissipation is derived from $V_{DD} = 5.25 \text{ V}, V_B = 2.4 \text{ V}, V_{COL} = 3.5 \text{ V}, 20 \text{ LEDs ON per character}, 20\% DF.$
- HCMS-2353 derate above 71°C at 23 mW/°C, Rθ_{J-A} = 45°C/W.
 Derating based on Rθ_{PC-A} = 35°C/W per display for printed circuit board assembly.
- 4. 1.59 mm (0.063") Below Body

Recommended Operating Conditions

Over Operating Range (-55°C to + 100°C)

Parameter	Symbol	Min.	Тур.	Max	Units
Supply Voltage	V_{DD}	4.75	5.00	5.25	V
Data Out Current, Low State	l _{OL}			1.6	mA
Data Out Current, High State	loн			-0.5	mA
Column Input Voltage	V_{COL}	2.75	3.0	3.5	V
Setup Time	t _{SETUP}	10			ns
Hold Time	t _{HOLD}	25			ns
Clock Pulse Width High	twh(clock)	50			ns
Clock Pulse Width Low	t _{WL(CLOCK)}	50			ns
Clock High to Low Transition	t _{THL}			200	ns
Clock Frequency	f _{CLOCK}			5	MHz

Electrical Characteristics

Over Operating Range (-55°C to + 100°C)

Parameter	Symbol	Test Conditions	Min	Typ.*	Max	Units
Supply Current, Dynamic ^[1]	I _{DDD}	f _{CLOCK} = 5 MHz		6.2	7.8	mA
Supply Current, Static ^[2]	I _{DDDSoff}	$V_B = 0.4 \text{ V}$, Data and Clock = 0.4 V		1.8	26	mA
	I_{DDDSon}	$V_B = 2.4 \text{ V}$, Data and Clock = 0.4 V		2.2	6.0	
Column Input Current	I _{COL}	V _B = 0.4 V			10	μΑ
		V _B = 2.4 V		500	650	mA
Input Logic High Data, V _B , Clock	V _{IH}	V _{DD} = 4.75 V	2.0			V
Input Logic Low Data, V _B , Clock	V _{IL}	V _{DD} = 5.25 V			0.8	V
Input Current	II	V _{DD} = 5.25 V				
Data		$V_{l}^{[3]} = 2.4 \text{ V (Logic High) or}$	-46	-60	-103	μΑ
Clock, V _B		$V_{l}^{[3]} = 0.4 \text{ V (Logic Low)}$	-92	-120	-206	
Data Out Voltage	V _{OH}	V _{DD} = 4.75 V	2.4	4.2		V
		$I_{OH} = -0.5 \text{ mA}$				
		$I_{COL} = 0 \text{ mA}$				
	V_{OL}	V _{DD} = 5.25 V		0.2	0.4	V
		$I_{OL} = 1.6 \text{ mA}$				
		$I_{COL} = 0 \text{ mA}$				
Power Dissipation Per Package ^[4]	P _D	V _{DD} = 5.0 V		668		mW
		$V_{COL} = 3.5 V$				
		17.5% DF				
		$V_B = 2.4 \text{ V}$				
		15 LEDs ON per Character				
Thermal Resistance	Rθ _{J-PIN}			10		°C/W
IC Junction-to-Pin [5]						
Leak Rate					5x10 ⁻⁸	cc/sec

^{*}All typical values specified at $V_{DD} = 5.0 \text{ V}$ and $T_A = 25$ °C.

Notes:

- 1. I_{DD} Dynamic is the IC current while clocking column data through the on-board shift register at a clock frequency of 5 MHz, the display is not illuminated.
- $2. \ \ I_{DD} \, Static \, is \, the \, IC \, current \, after \, column \, data \, is \, loaded \, and \, not \, being \, clocked \, through \, the \, on-board \, shift \, register.$
- 3. V_I represents the input voltage to an input pin.
- 4. Four characters are illuminated with a typical ASCII character composed of 15 dots per character.
- 5. IC junction temperature T_J (IC) = $(P_D)(R\theta_{J-PIN} + R\theta_{PC-A}) + T_A$.

Optical Characteristics at $T_A = 25^{\circ}C$

High Performance Green HCMS-2353

Description	Symbol	Test Condition	Min.	Typ.*	Max.	Units
Peak Luminous Intensity per LED ^[6] (Character Average)	I _V РЕАК	$V_{DD} = 5.0 \text{ V}$ $V_{COL} = 3.5 \text{ V}$ $V_{B} = 2.4 \text{ V}$ $T_{i} = 25^{\circ}C^{[7]}$	2400	3000		μcd
Dominant Wavelength ^[8,9]	λ_{d}			574		nm
Peak Wavelength	λ_{PEAK}			568		nm

Yellow HCMS-2351

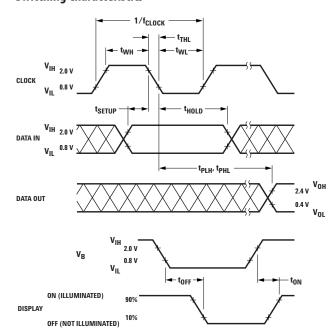
Description	Symbol	Test Condition	Min	Typ.*	Max.	Units
Peak Luminous Intensity per LED ^[6] (Character Average)	I _v peak	$V_{DD} = 5.0V$ $V_{COL} = 3.5 V$ $V_{B} = 2.4V$ $Ti = 25^{\circ}C^{[7]}$	1600	2400		μcd
Dominant Wavelength [8,9]	λ_{d}			585		nm
Peak Wavelength	λρεακ			583		nm

^{*}All typical values specified at $V_{DD} = 5.0 \text{ V}$ and $T_A = 25^{\circ}\text{C}$ unless otherwise noted.

Notes:

- 6. These LED displays are categorized for luminous intensity, with the intensity category designated by a letter code on the back of the package.
- 7. T_i refers to the initial case temperature of the display immediately prior to the light measurement.
- 8. Dominant wavelength, λ_d , is derived from the CIE Chromaticity Diagram, and represents the single wavelength which defines the color of the device.
- $9. \ Categorized \ for \ color \ with \ the \ color \ category \ designated \ by \ a \ number \ on \ the \ back \ of \ the \ package.$

Switching Characteristics



Parameter	Condition	Тур.	Max.	Units
f _{clock} CLOCK Rate			5	MHz
t _{PLH} , t _{PHL}	$C_L = 15 pF$		105	ns
Propagation Delay	$R_L = 2.4 \text{ k}\Omega$			
CLOCK to DATA OUT				
t _{OFF}				
V_B (0.4 V) to		4	5	μs
Display OFF				
t _{ON}				
V_B (2.4 V) to		1	2	
Display ON				

Electrical Description

The display contains four 5 x 7 LED dot matrix characters and two CMOS integrated circuits, as shown in Figure 1. The two CMOS integrated circuits form an on-board 28 bit serial-in/parallel-out shift register that will accept standard TTL logic levels. The Data Input, pin 12, is connected to bit position 1 and the Data Output, pin 7, is connected to bit position 28. The shift register outputs control constant current sinking LED row drivers. A logic 1 stored in the shift register enables the corresponding LED row driver and a logic 0 stored in the shift register disables the corresponding LED row driver.

The electrical configuration of these CMOSIC alphanumeric displays allows for an effective interface to a display controller circuit that supplies decoded character information. The row data for a given column (one 7 bit byte per character) is loaded (bit serial) into the on-board 28 bit shift register with high to low transitions of the Clock input. To load

decoded character information into the display, column data for character 4 is loaded first and the column data for character 1 is loaded last in the following manner. The 7 data bits for column 1, character 4, are loaded into the on-board shift register. Next, the 7 data bits for column 1, character 3, are loaded into the shift register, shifting the character 4 data over one character position. This process is repeated for the other two characters until all 28 bits of column data (four 7 bit bytes of character column data) are loaded into the on-board shift register. Then the column 1 input, V_{COL} pin 1, is energized to illuminate column 1 in all four characters. This process is repeated for columns 2, 3, 4 and 5. All V_{COL} inputs should be at logic low to insure the display is off when loading data. The display will be blanked when the blanking input VB, pin 8, is at logic low regardless of the outputs of the shift register or whether one of the V_{COL} inputs is energized. Refer to Application Note 1016 for drive circuit information.

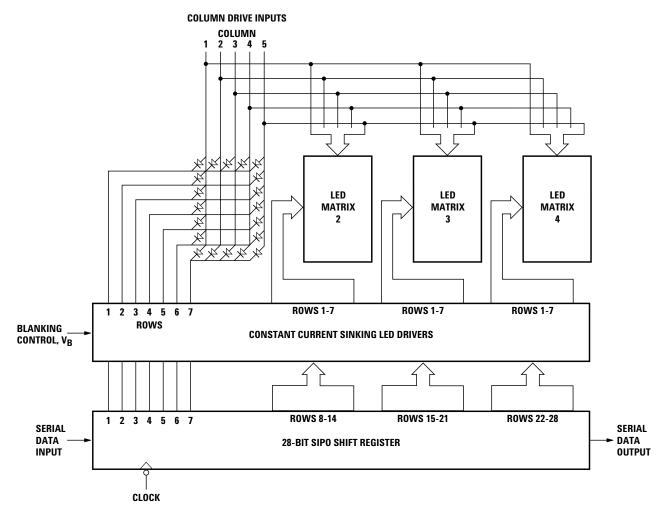


Figure 1. Display block diagram.

ESD Susceptibility

The display has an ESD susceptibility ratings of CLASS 3 of MIL-STD-883E, HBM. It is recommended that normal CMOS handling precautions be observed with these devices.

Soldering and Post Solder Cleaning

These displays may be soldered with a standard wave solder process using either an RMA flux and solvent cleaning or an OA flux and aqueous cleaning. For optimum soldering, the solder wave temperature should be 245 $^{\circ}$ C and the dwell time for any display lead passing through the wave should be 1.5 to 2 seconds. For more detailed information, refer to Application Note 1027, Soldering LED Components.

Contrast Enhancement

When used with the proper contrast enhancement filters, the display is readable in sunlight.

Refer to Application Note 1029, Luminous Contrast and Sunlight Readability of the HDSP-235X Series Alphanumeric Displays for Sunlight Viewable Applications, for information on contrast enhancement for sun-light and daylight ambient. Refer to Application Note 1015, Contrast Enhancement Techniques for LED Displays, for information on contrast enhancement in moderate ambients

Night Vision Lighting

When used with the proper NVG/DV filters, HCMS-235x display may be used in night vision lighting applications. For a list of NVG/DV filters and a discussion on night vision lighting technology, refer to Application Note 1030, LED Displays and Indicators and Night Vision Imaging System Lighting.

Controller Circuits, Power Calculations, and Display Dimming

Refer to Application Note 1016, Using the HDSP-2000 Alphanumeric Display Family, for information on controller circuits to drive these displays, how to do power calculations, and a technique for display dimming.

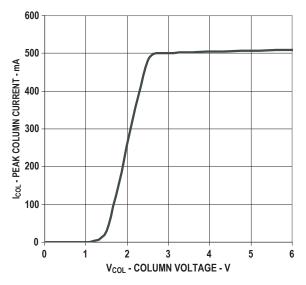


Figure 2. Peak column current vs. column voltage at $T_A = 25$ °C.

